■ MN101C309 , MN101C30A

Туре	MN101C309	MN101C30A			
ROM (x8-bit)	24 K	32 K			
External memory can be expanded					
RAM (×8-bit)	1 K	1.5 K			
External memory can be expanded					
Package	LQFP064-P-1414 *Lead-free, SDIP064-P-0750C *Lead-free (under planning)				
(Conventional Package)	(SDIP064-P-0750)				
Minimum Instruction	•	V to 5.5 V, 20 MHz)			
Execution Time	0.238 μs (at 2.7 V to 5.5 V, 8.39 MHz)				
	1.00 µs (at 2.0 V to 5.5 V, 2 MHz)*				
	125 μ s (at 2.0 V to 5.5 V, 32.768 kHz)* * The lower limit for operation guarantee for EPROM built-in type is 2.7 V.				
Interrupts	• RESET • Watchdog • External 0 • External 1 • External 1				
····	• Timer 1 • Timer 2 • Timer 3 • Timer 4 • Timer 5 •				
	• Automatic transfer finish • A/D conversion finish				
Timer Counter	· •	utput, event count, generation of remote control carrier)			
	Clock source				
	external clock input Interrupt source coincidence with compare register 0				
	Timer counter 1 : 8-bit × 1 (square-wave output, event count, synchronous output event) Clock source				
	external clock input				
	Interrupt source ······ coincidence with compare register 1				
	Timer counter 0, 1 can be cascade-connected.				
	Timer counter 2 : 8-bit × 1 (square-wave/8-bit PWM output, event count, synchronous output event)				
	Clock source ······ 1/1, 1/4 of system clock frequency; 1/1 of XI oscillation clock frequency;				
	external clock input				
	Interrupt source coincidence with co	mpare register 2			
	Timer counter 3: 8-bit × 1				
	(square-wave output, event count, generation of remo	ote control carrier, serial 0 band rate timer) clock frequency; 1/1 of OSC oscillation clock frequency;			
	external clock input				
	Interrupt source coincidence with co				
	Timer counter 2, 3 can be cascade-connected.				
	Timer counter 4: 16-bit × 1				
	(square-wave/16-bit PWM output, event count, syncl	hronous output event, input capture)			
		clock frequency; 1/1 of OSC oscillation clock frequency;			
	external clock input				
	Interrupt source coincidence with co	•			
	Time base timer (one-minute count setting, independen				
		frequency; 1/1, 1/8192 of OSC oscillation clock frequency scillation clock frequency			
	Interrupt source coincidence with co	- ·			
	Watchdog timer	•			
		1/1048576 of system clock frequency (ROM option)			
	- · · · · · · · · · · · · · · · · · · ·				

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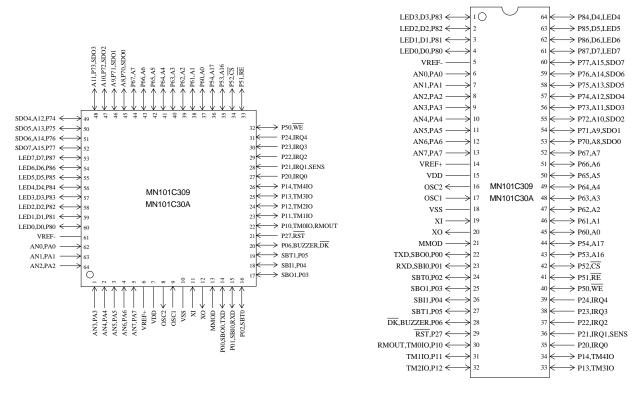
Serial Inter	Serial Interface Serial 0 : synchronous type/simple UART (half-duplex) × 1 Clock source				
		Seria	al 1 : synchronous type × 1 Clock source ··················· 1/2, 1/8, 1/64 of system clock frequency; output of timer counter 3		
I/O Pins	I/O	41	• Common use • Specified pull-up resistor available • Input/output selectable (bit unit)		
	Input	13	Common use Specified pull-up resistor available		
A/D Inputs		10-bit × 8-ch. (with S/H)			
Special Por	ts	Buzz	Buzzer output, remote control carrier signal output, high-current drive port		

Electrical Characteristics

Supply current

Parameter	Symbol	Condition		Limit		
rarameter	Symbol			typ	max	Unit
Operating supply current	IDD1	fosc = 20 MHz, VDD = 5 V		25	60	mA
	IDD2	fx = 32.768 kHz, VDD = 3 V		30	100	μА
Supply current at HALT	IDD3	$fx = 32.768 \text{ kHz}, VDD = 3 \text{ V}, Ta = 25^{\circ}\text{C}$		4	8	μА
		$fx = 32.768 \text{ kHz}, VDD = 3 \text{ V}, Ta = 85^{\circ}\text{C}$			18	μА
Supply ourrent at STOR	IDD4	$VDD = 5 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$			2	μА
Supply current at STOP		$VDD = 5 \text{ V}, \text{ Ta} = -40^{\circ}\text{C to } +85^{\circ}\text{C}$			20	μА





LQFP064-P-1414 *Lead-free

SDIP064-P-0750C *Lead-free (under planning) (SDIP064-P-0750)

Support Tool

In-circuit Emulator	PX-ICE101C/D+PX-PRB101C30-LQFP064-P-1414	
EPROM Built-in Type	Туре	MN101CP30ABL
	ROM (× 8-bit)	32 K
	RAM (× 8-bit)	1.5 K
	Minimum instruction execution time	0.10 µs (at 4.5 V to 5.5 V, 20 MHz)
		0.238µs (at 2.7 V to 5.5 V, 8 MHz)
	Package	LQFP064-P-1414 *Lead-free, SDIP064-P-0750C *Lead-free (under planning)
	(Conventional Package)	(SDIP064-P-0750)

MN101C309, MN101C30A \square

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